		Attorney Reference			
	DECLARATION FOR POWER OF ATTORNEY, DE	UNITED STATES PATENT APPLICATION, SIGNATION OF CORRESPONDENCE ADDRESS			
As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and that I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled  COLLECTIVE SUBSTRATE, SEMICONDUCTOR ELEMENT MOUNT, SEMICONDUCTOR DEVICE, IMAGING DEVICE, LIGHT EMITTING DIODE					
1					
the specification	n of which				
[ ] is attached [ ] was filed on and was am [X] was filed un Serial No	nnended on nended on nder the Patent Cooperation Treaty	, as Application Serial No, [if applicable]. onJuly 21, 2005 United States of America being designated.			
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.  I acknowledge the duty to disclose to the Patent and Trademark Office information known to me to be material to					
patentability as defined in Title 37, Code of Federal Regulations, §1.56(a).  I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:  Prior Foreign Application(s)					
Country	Number Date Filed	Priority Claimed Yes No			
Japan	2004-231085	August 6, 2004  √			
Japan	2005-047481	February 23, 2005   √			
I hereby appoint the following attorneys to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith: Steven M. Rabin (Reg. No. 29,102), Robert H. Berdo, Jr. (Reg. No. 38,075), Phillip G. Avruch (Reg. No. 46, 076) and Allen Wood (Reg. No. 28,134).  Address all correspondence to:					
*23995*					
23995 Patent Trademark Office					
domestic attorned Trademark Offi undersigned. Ir	essignee, if any, and/or, if the un ey, patent attorney, patent agent, o ice regarding this application w	attorneys named herein to accept and follow instructions from the adersigned is not a resident of the United States, the undersigned's or patent representative as to any action to be taken in the Patent and atthout direct communication between the U.S. attorneys and the con(s) from whom instructions may be taken, the U.S. attorneys named			
I hereby de	clare that all statements made he	erein of my own knowledge are true and that all statements made on			

I hereby decl information and belief are information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may incompliant the united States.

issued thereon.		the validity of the application	n or any paten
Signature: Kenjiro Higaki	Date:	April 12	, 200 <u>6</u>
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Signature: Jadamu (Jahridu: Third Joint Inventor: Sadamu ISHIDU Citizenship: Japanese Residence and Post Office Address: c/o A. L. M. T. Corp.,	Date:	April 14	, 200 <u>_6</u> _

## DECLARATION FOR UNITED STATES PATENT APPLICATION, POWER OF ATTORNEY, DESIGNATION OF CORRESPONDENCE ADDRESS

## Page 2 of 2

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